

YOM/2006——2A 60V Opto-MOS

概述 Features

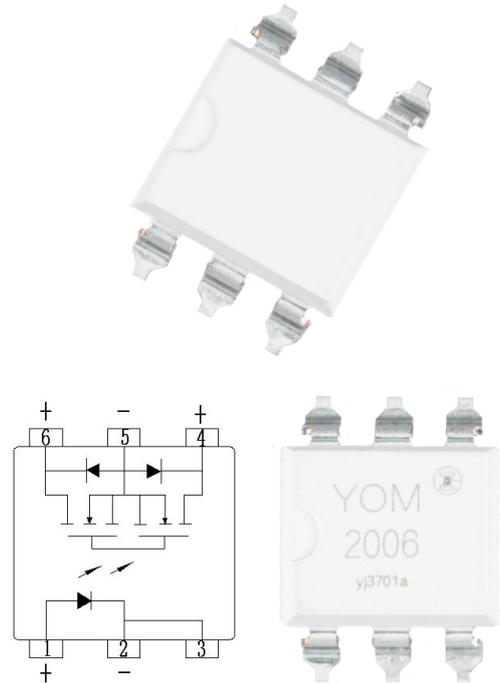
- 交直流通用 AC&DC load
- 负载电流至2A Load current up to 2A
- 击穿电压60V Breakdown voltage 60V
- 介质耐压5000V Dielectric strength 5000V
- 符合RoHS RoHS compliant

应用 Applications

- 高速检测设备 High-speed inspection machines
- 程控交换设备 Telephone equipment
- 计算机 Computer

打印标志 Marking information

| Part number | Package | Marking |
|-------------|---------|----------|
| YOM/2006S | SMD6 | YOM 2006 |



极限值 Absolute maximum ratings

(Ta=25℃)

| 特性参数/Parameter | | 符号/Symbol | 测试条件/Test condition | 最小值/Min. | 典型值/Typ. | 最大值/Max. | 单位/Unit |
|--------------------------------|------------------------------|------------|---|----------|----------|----------|-----------|
| 输入端/Input | LED 反向电压/LED reverse voltage | V_R | | 6 | | | V |
| | LED 正向电流/LED forward current | I_F | | | | 50 | mA |
| | 功耗/Power dissipation | P_{in} | | | | 50 | mW |
| 输出端/Output | 击穿电压/Breakdown voltage | BV_{DSS} | | 60 | | | V |
| | 功耗/Power dissipation | P_{out} | | | | 800 | mW |
| | 额定电流/On-state current | I_L | | | | 2 | A |
| | 峰值电流/Peak current | I_{peak} | A connection: 100ms (1 shot), VL=DC | | 4 | | A |
| 介质耐压/I/O Dielectric strength * | | V_{ISO} | $I_{ISO} \leq 0.3mA$ | 5000 | | | V_{rms} |
| 工作温度/Operating temperature | | T_{opr} | | -30 | | 85 | ℃ |
| 储存温度/Storage temperature | | T_{stg} | | -40 | | 125 | ℃ |

“*”：RH=40 to 60%, T=20~30℃, AC for 1minute.

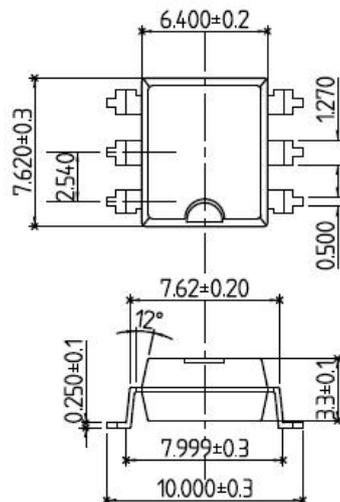
电参数 Electrical parameters

(Ta=25℃)

| 特性参数/Parameter | | 符号 /Symbol | 测试条件 /Test condition | 最小 值 /Min. | 典型值 /Typ. | 最大值 /Max. | 单位 /Unit |
|--------------------------------------|--|---------------|----------------------------|------------------|--------------|--------------|-------------|
| 输入端/Input | LED 正向电压/LED forward voltage | V_F | $I_F=10mA$ | | 1.2 | 1.3 | V |
| | LED 反向电流/LED reverse current | I_R | $V_R=5V$ | | | 10 | μA |
| 输出端/Output | 断态泄漏电流 /Output off-state leakage current | I_{Leak} | $V_o=60V$ | | | 10 | μA |
| 耦合特性 /Transfer characteristics | LED 触发电流/LED trigger current | I_{FT} | | | 3 | 8 | mA |
| | 推荐的工作电流 /Recommend operating current | I_{in} | | 10 | | 18 | mA |
| | 导通电阻/Output on-state resistance | R_{on} | $I_{in}=10mA, I_D=2A$ | | | 0.1 | Ω |
| | 导通时间/Turn on time | T_{on} | $I_{in}=10mA, I_D=400mA$ | | | 2 | ms |
| | 关断时间/Turn off time | T_{off} | $I_{in}=10mA, I_D=400mA$ | | | 1 | ms |
| | 电容/I/O capacitance | C | | | | | 10 |

外形尺寸 Outline dimension :mm

1、SMD6



注：未注公差为±0.05mm。

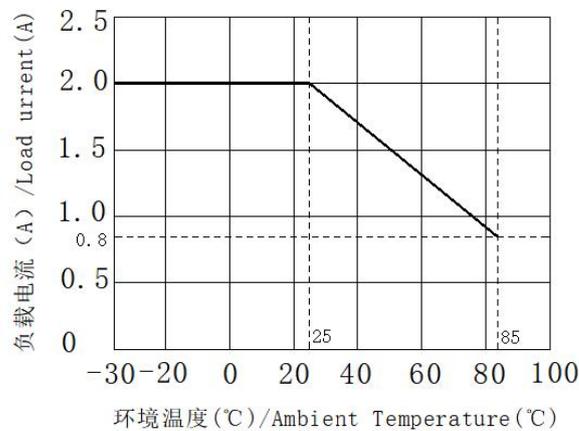
订货信息 Ordering information

| 订货信息/Ordering information | | | | | | |
|------------------------------------|---|----|----|-----|---|---|
| | Y | OM | B/ | 200 | 6 | S |
| 公司商标代号 Company symbol | | | | | | |
| MOS 直流输出 SSR: MOS DC Output SSR | | | | | | |
| 常开型 N.O.: 默认 Nil 常闭型 N.C.: B | | | | | | |
| 负载电流 Load current: 200-2A | | | | | | |
| 击穿电压 BV_{DSS} : 6-60V | | | | | | |
| S: SMD | | | | | | |

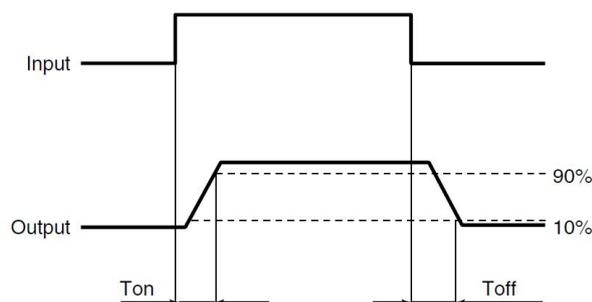
特性曲线 Characteristic data

1. 负载电流与环境温度关系曲线

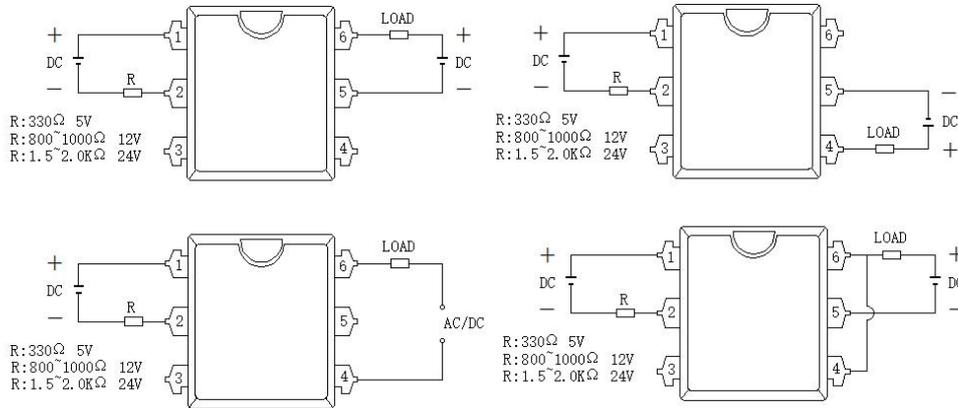
Load current VS. ambient temperature



接通和关断时间关系 Turn on and turn off time



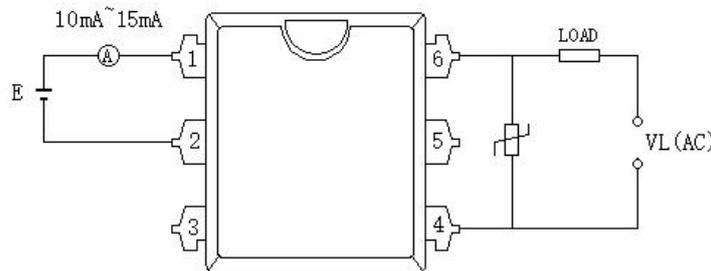
接线图 Wiring diagram



推荐使用的条件 Recommended driving condition

请确保输入电流大于 10mA，推荐输入电流为 15mA。请参考下图：

Please make sure the input current more 10mA, Recommending input current 15mA.



注意事项 Notes

a) 工作环境温度超过 25℃时请降额使用。参见特性曲线 1。

When ambient temperature is above 25℃, the load current must be reduced. (see characteristic data)

b) 继电器接线时，务必保证输入端极性的正确，以免损坏继电器。

Ensuring the polarity is correct when connecting the input lines, otherwise the wrong connection will damage the relay.

关于防静电对策 Cautions for static electricity

a. 操作 MOS 输出继电器的作业人员，请穿戴防静电工作服，通过 500kΩ~1MΩ 左右的保护电阻，实施人体接地。

a. Employees handling relays should wear anti-static clothes and should be grounded through protective resistance of 500kΩ to 1MΩ.

b. 请在作业台上装有带导电性的金属板或具有防静电的专用板，并对测量仪器和治具等实施接地。

b. A conductive metal sheet should be placed over the work table. Measuring instruments and jigs should be grounded.

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- c. 使用电烙铁时，对电烙铁前端进行接地。（建议使用低电压用的电烙铁。）
c. When using soldering irons, either use irons with low leakage current, or ground the tip of the soldering iron. (Use of low-voltage soldering irons is also recommended.)
- d. 组装时使用的设备等也应正确的接地。
d. Devices and equipment used in assembly should also be grounded.
- e. 对印刷电路板和机器进行包装时，请避免使用发泡苯乙烯、聚乙烯等带电性的高分子材料。
e. When packing printed circuit boards and equipment, avoid using high-polymer materials such as foam styrene, plastic, and other materials which carry an electrostatic charge.
- f. 对 MOS 输出继电器进行储存和搬运时，请在不易产生静电的环境(例如湿度 45~60%)中通过导电性包装材料进行保护。
f. When storing or transporting relays, the environment should not be conducive to generating static electricity (for instance, the humidity should be between 45 and 60%), and relays should be protected using conductive packing materials.